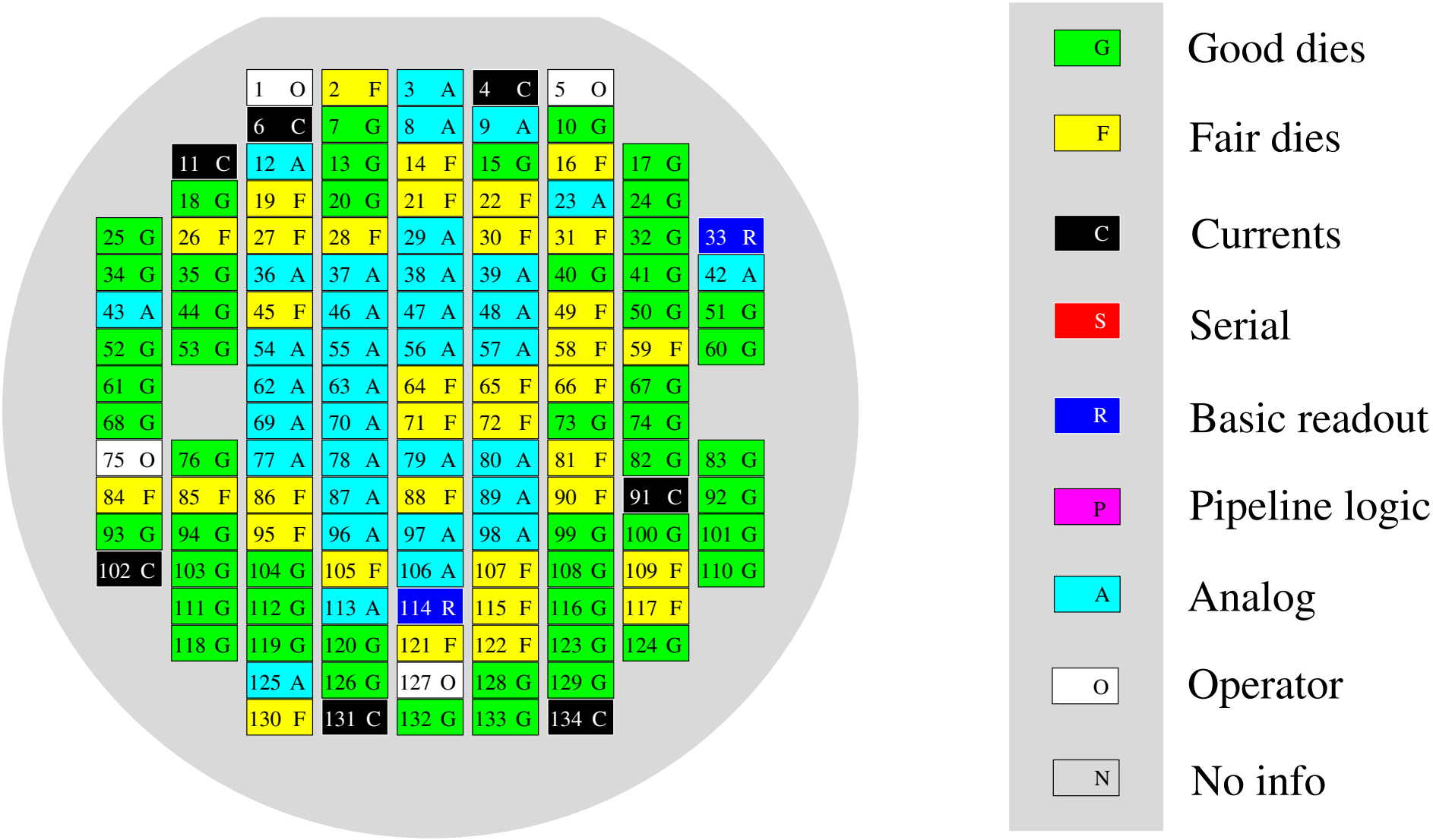
Types of die failures for wafer 176 s/n: Y21316-09-19

Date: 07/08/99